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Response Under 37 C.F.R. § 1.116-  
Expedited Procedure - Examining Group 1725

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of:

NIGEL F. CLAY, ET AL

Serial No.: 10/063,300

Filed: April 9, 2002

For: TIN-AND ZINC-BASED SOLDER FILLERS FOR  
ALUMINUM BODY PARTS AND METHODS OF  
APPLYING THE SAME

Group Art Unit: 1725

Examiner: Len Tran

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SEP 04 2003  
TC 1700

Attorney Docket No.: FMC 1416 PUS/200-1759

**AMENDMENT UNDER 37 C.F.R. § 1.116**

Mail Stop AF  
Commissioner for Patents  
U.S. Patent & Trademark Office  
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Alexandria, VA 22313-1450

Sir:

In response to the final Office Action mailed June 24, 2003, please amend the  
above-identified application as follows:

**CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8**

I hereby certify that this paper, including all enclosures referred to herein, is being deposited with the United States Postal Service as first-class mail, postage pre-paid, in an envelope addressed to: Mail Stop AF, Commissioner for Patents, U.S. Patent & Trademark Office, P.O. Box 1450, Alexandria, VA 22313-1450 on:

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